PART OBSOLETE – NO ALTERNATE PART



A Product Line of Diodes Incorporated



ZXTP558L



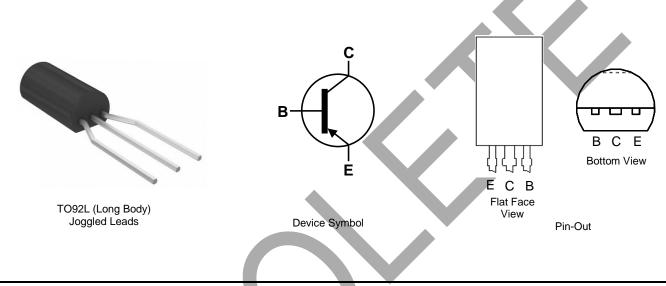
400V PNP High Voltage Transistor in TO92L

Features and Benefits

- BV_{CEO} > 400V
- Power dissipation P_D = 1W
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High-Reliability

Mechanical Data

- Case: TO92L (Long Body)
- Case Material: Molded Plastic, "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Weight: 0.272 grams (Approximate)



Ordering Information (Note 4)

Product	Package	Marking	Leads	Quantity
ZXTP558LSTZ	TO92L	ZXTP558	Joggled	2,000 taped
2,111 0002012			0099.00	per Ammo Box

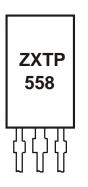
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant..

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



ZXTP558 = Product Type Marking Code





Absolute Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-400	V
Collector-Emitter Voltage	V _{CEO}	-400	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current	I _C	-200	mA
Peak Pulse Current	I _{CM}	-500	mA

Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	1	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ extsf{ heta}JA}$	125	°C/W
Thermal Resistance, Junction to Lead (Note 6)	$R_{ extsf{ heta}JL}$	50	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	С°

ESD Ratings (Note 7)

Notes:

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	8,000	V	3B
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

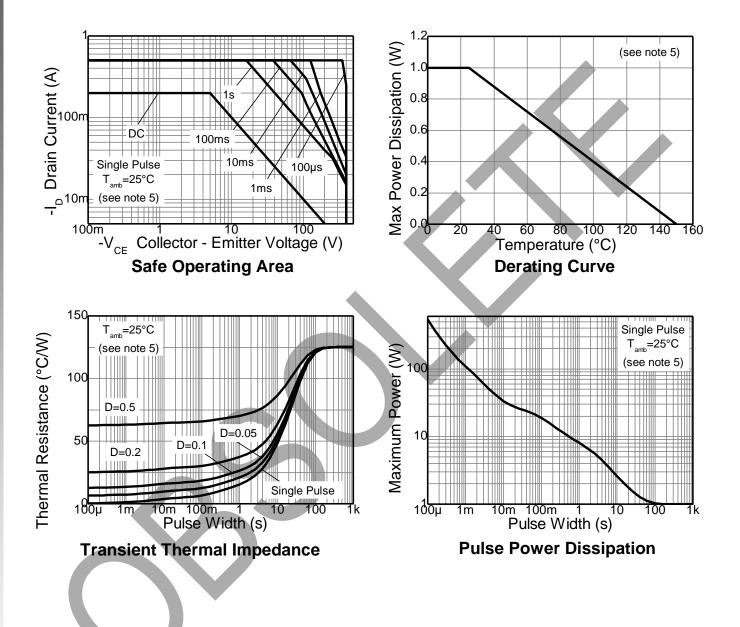
For the through-hole device mounted vertically, in still air conditions, with the lead length 6mm from the bottom of package to the board.
Thermal resistance from junction to solder-point (2mm from the bottom of package along the collector lead).
Refer to JEDEC specification JESD22-A114 and JESD22-A115.







Thermal Characteristics and Derating Information







Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

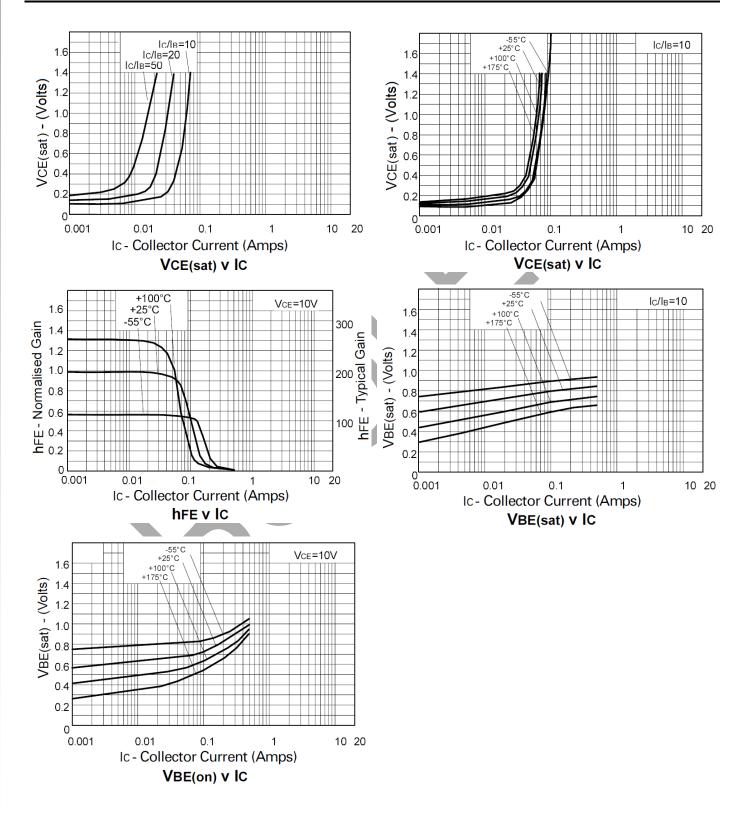
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-400			V	I _C = -100μA
Collector-Emitter Breakdown Voltage (Note 8)	BV _{CEO}	-400	_		V	$I_{\rm C} = -1 \text{mA}$
Emitter-Base Breakdown Voltage	BVEBO	-7	_		V	I _E = -100μA
Collector Cutoff Current	I _{CBO}			-100	nA	$V_{CB} = -320V$
Emitter Cutoff Current	I _{CES}	—	_	-100	nA	V _{CE} = -320V
Base Cutoff Current	I _{EBO}			-100	nA	V _{BE} = -5V
DC Current Gain (Note 8)	h _{FE}	100	_		-	$I_{C} = -1mA, V_{CE} = -10V$
		100	_	300		I _C = -50mA
Collector-Emitter Saturation Voltage (Note 8)	V _{CE(sat)}	—	—	-0.2	V	$I_{\rm C} = -20 {\rm mA}, I_{\rm B} = -2 {\rm mA}$
		—	—	-0.5		$I_{\rm C} = -50 {\rm mA}, I_{\rm B} = -6 {\rm mA}$
Base-Emitter Turn-On Voltage	V _{BE(on)}	—	—	-0.9	V	$V_{CE} = -10V, I_{C} = -50mA$
Base-Emitter Saturation Voltage	V _{BE(sat)}			-0.9	V	$I_{\rm C} = -50 {\rm mA}, I_{\rm B} = -5 {\rm mA}$
Output Capacitance (Note 8)	Cobo	—		5	рF	$V_{CB} = -20V, f = 1.0MHz$
Current Gain-Bandwidth Product	fT	50			MHz	$V_{CE} = -20V$, $I_C = -10mA$, f = 20MHz
Turn-On Time	t _{on}		95	-	ns	$V_{CE} = -100V, I_{C} = -50mA$
Turn-Off Time	t _{off}	_	1600		ns	$I_{B1} = 5mA, I_{B2} = -10mA$

8. Measured under pulsed conditions. Pulse width \leq 300µs; Duty cycle \leq 2%. Note:





Typical Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

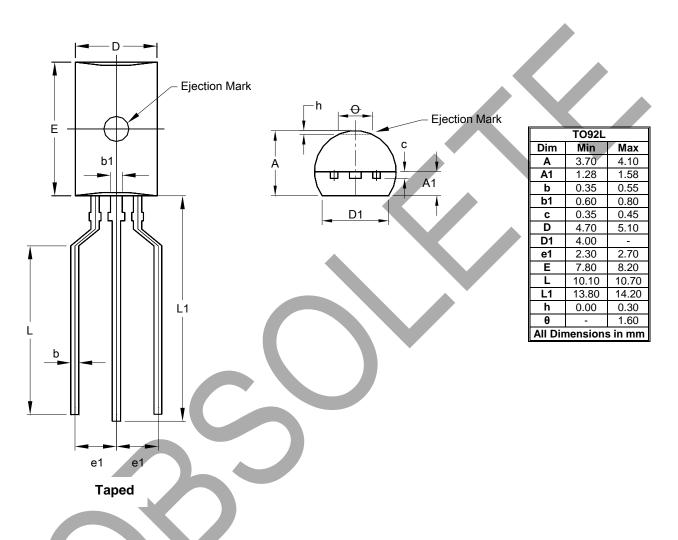






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to voltage spacing between terminals.





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